

+5.0V, ±15kV ESD-Protected, Fail-Safe, Hot-Swap, RS-485/RS-422 Transceivers

■ Description

The TK13086E +5.0V, ±15kV ESD-protect-ed, RS-485/RS-422 transceivers feature one driver and one receiver. These devices include fail-safe circuitry, guaranteeing a logic-high receiver output when receiver inputs are open or shorted. The receiver outputs a logic-high if all transmitters on a terminated bus are disabled (high impedance).

The TK13086E driver slew rates is not limited, making transmit speeds up to 16Mbps possible. It is intended for full-duplex communications. The TK13086E family transceivers draw 1.2mA of supply current when unloaded or when fully loaded with the drivers disabled. All devices have a 1/8-unit load receiver input impedance, allowing up to 256 transceivers on the bus. It is available in 14-pin SOIC packages. The devices operate over the commercial, extended, and automotive temperature ranges.

■ Features

- 1 transmitter and 1 receivers of the serial data of the standard RS-485
- Transmit speeds up to 16Mbps
- Auto Shutdown function provide low power consumption
- Supply voltage range: 5.0V ± 5%
- Operating temperature range: -40 ~ +85 °C
- ESD protection up to 2000V for transmitter input and receiver output (TTL/CMOS levels) and up to 15000V for transmitter output and receiver input (RS-485 levels)
- Enhanced ESD Specifications:
 - ±15kV IEC61000-4-2 Air Discharge
 - ±8kV IEC61000-4-2 Contact Discharge

■ Ordering Information

Part Number	Package	Packing	Temperature(TA)	Package Qty	ESD
TK13086EASD	SOIC-14	Reel	-40°C ~ 125°C	2500	±15KV
TK13086EESD	SOIC-14	Reel	-40°C ~ 85°C	2500	±15KV

Note: Please contact us to customize DIP packaging device.

■ Pin Description

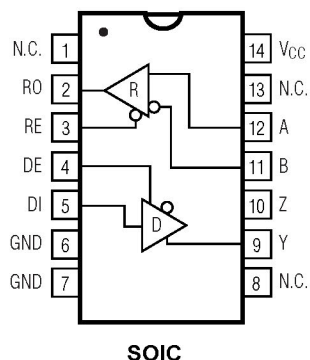


Table 1. Pin Description

Pin Num	Symbol	Pin Description
01	N.C.	No Connect. Not internally connected, can be connected to GND.
02	RO	Receiver Output. When $\overline{RE}$ is low and if $A - B \geq -50\text{mV}$, RO will be high; if $A - B \leq -200\text{mV}$, RO will be low.
03	$\overline{RE}$	Receiver Output Enable. Drive $\overline{RE}$ low to enable RO; RO is high impedance when $\overline{RE}$ is high. Drive $\overline{RE}$ high and DE low to enter low-power shutdown mode.
04	DE	Driver Output Enable. Drive DE high to enable driver outputs. These outputs are high impedance when DE is low. Drive $\overline{RE}$ high and DE low to enter low-power shutdown mode.
05	DI	Driver Input. With DE high, a low on DI forces noninverting output low and inverting output high. Similarly, a high on DI forces noninverting output high and inverting output low.
06	GND	Ground
07	GND	Ground
08	N.C.	No Connect. Not internally connected, can be connected to GND.
09	Y	Noninverting Driver Output
10	Z	Inverting Driver Output
11	B	Inverting Receiver Input
12	A	Noninverting Receiver Input
13	N.C.	No Connect. Not internally connected, can be connected to GND.
14	VCC	Positive Supply; $4.75\text{V} \leq VCC \leq 5.25\text{V}$

Table 2. Transmitter Truth Table

Inputs			Outputs	
$\overline{RE}$	DE	DI	Z	Y
X	H	H	L	H
X	H	L	H	L
L	L	X	Z	Z
H	L	X	ZZ	

Note : H – high level, L – low level , X –don't care, Z – third state

Table 3. Receiver Truth Table

Inputs			Outputs
$\overline{RE}$	DE	A, B	RO
L	X	$\geq -0,05 B$	H
L	X	$\leq -0,2 B$	L
L	X	BH	H
H	H	X	Z
H	L	X	ZZ

Note : H – high level, L – low level , BH – inputs not used, X –don't care, Z – third state,
 ZZ – inputs and outputs are in the third state

Table 4. Recommended Operating Condition

Symbol	Parameter	Limit		Unit
		min	max	
V_{CC}	Supply voltage	4.75	5.25	V
V_{IL}	Input low voltage DI, DE, $\overline{RE}$ pins	0	0.8	V
V_{IH}	Input high voltage DI, DE, $\overline{RE}$ pins	2.0	V_{CC}	V
V_{OD}	Transmitter output voltage	-7.0	12.0	V
V_{IR}	Receiver input voltage	-7.0	12.0	V
V_{OR}	Receiver output voltage	0	V_{CC}	V
V_{TH}	Receiver differential threshold voltage	± 50	± 200	V
T	Ambient temperature	-40	85	°C

Table 5. Maximum Ratings

Symbol	Parameter	Limit		Unit
		min	max	
V_{CC}	Supply voltage	–	7.0	V
V_{IL}	Input voltage on pins DI, DE, $\overline{RE}$	-0.3	7.0	V
V_{OD}	Transmitter output voltage	-13	13	V
V_{IR}	Receiver input voltage	-13	13	V
V_{OR}	Receiver output voltage	-0.3	$V_{CC}+0.3$	V

* Stresses beyond those listed under “maximum ratings” may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

Table 6. Electrical Parameters

($V_{CC} = 5V \pm 5\%$)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
DRIVER							
V _{CC} Supply-Voltage Range	V _{CC}			4.5		5.5	V
Differential Driver Output	V _{OD}	R _L = 100Ω (RS-422), Figure 1		3		V _{CC}	V
		R _L = 54Ω (RS-485), Figure 1		2		V _{CC}	
		No load				V _{CC}	
Change in Magnitude of Differential Output Voltage	ΔV _{OD}	R _L = 100Ω or 54Ω, Figure 1 (Note 2)				0.2	V
Driver Common-Mode Output Voltage	V _{OC}	R _L = 100Ω or 54Ω, Figure 1			V _{CC} / 2	3	V
Change in Magnitude of Common-Mode Voltage	ΔV _{OC}	R _L = 100Ω or 54Ω, Figure 1 (Note 2)				0.2	V
Input-High Voltage	V _{IH}	DE, DI, $\overline{\text{RE}}$, TXP, RXP, H/ $\overline{\text{F}}$		3			V
Input-Low Voltage	V _{IL}	DE, DI, $\overline{\text{RE}}$, TXP, RXP, H/ $\overline{\text{F}}$				0.8	V
Input Hysteresis	V _{HYS}	DE, DI, $\overline{\text{RE}}$, TXP, RXP, H/ $\overline{\text{F}}$			100		mV
Input Current	I _{IN1}	DE, DI, $\overline{\text{RE}}$				±1	μA
Input Impedance First Transition		DE		1		10	kΩ
Input Current	I _{IN2}	TXP, RXP, H/ $\overline{\text{F}}$ internal pulldown		10		40	μA
SRL Input-High Voltage				V _{CC} - 0.4			V
SRL Input-Middle Voltage				V _{CC} x 0.3		V _{CC} x 0.7	V
SRL Input-Low Voltage						0.4	V
SRL Input Current		SRL = V _{CC}				75	μA
		SRL = GND		-75			
Output Leakage (Y and Z) Full Duplex	I _O	DE = GND, V _{CC} = GND or V _{CC}	V _{IN} = +12V			125	μA
			V _{IN} = -7V	-100			
Driver Short-Circuit Output Current	I _{OSD}	0 ≤ V _{OUT} ≤ +12V (Note 3)		40		250	mA
		-7V ≤ V _{OUT} ≤ V _{CC} (Note 3)		-250		-40	
		0 ≤ V _{OUT} ≤ +12V, +85°C ≤ T _A ≤ +125°C (Note 3)		40		270	
		-7V ≤ V _{OUT} ≤ V _{CC} , +85°C ≤ T _A ≤ +125°C (Note 3)		-270		-40	
Driver Short-Circuit Foldback Output Current	I _{OSDF}	(V _{CC} - 1V) ≤ V _{OUT} ≤ +12V (Note 3)		20			mA
		-7V ≤ V _{OUT} ≤ +1V (Note 3)				-20	
Thermal-Shutdown Threshold	T _{TS}				175		°C
Thermal-Shutdown Hysteresis	T _{TSH}				15		°C
Input Current (A and B)	I _{A, B}	DE = GND, V _{CC} = GND or V _{CC}	V _{IN} = +12V			125	μA
			V _{IN} = -7V	-100			
RECEIVER							
Receiver Differential Threshold Voltage	V _{TH}	-7V ≤ V _{CM} ≤ +12V		-200	-125	-50	mV
Receiver Input Hysteresis	ΔV _{TH}	V _A + V _B = 0V			15		mV
RO Output-High Voltage	V _{OH}	I _O = -1mA		V _{CC} - 0.6			V
RO Output-Low Voltage	V _{OL}	I _O = 1mA				0.4	V
Three-State Output Current at Receiver	I _{OZR}	0 ≤ V _O ≤ V _{CC}				± 1	μA
Receiver Input Resistance	R _{IN}	-7V ≤ V _{CM} ≤ +12V		96			kΩ
Receiver Output Short-Circuit Current	I _{OSR}	0V ≤ V _{RO} ≤ V _{CC}				±110	mA

Table 6. Electrical Parameters (continued)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
SUPPLY CURRENT						
Supply Current	I _{CC}	No load, $\overline{RE} = 0$, DE = V _{CC}		1.2	1.8	mA
		No load, $\overline{RE} = V_{CC}$, DE = V _{CC}		1.2	1.8	
		No load, $\overline{RE} = 0$, DE = 0		1.2	1.8	
Supply Current in Shutdown Mode	I _{SHDN}	$\overline{RE} = V_{CC}$, DE = GND		2.8	10	μA
ESD PROTECTION						
ESD Protection for Y, Z, A, and B		Human Body Model		±15		kV
		Contact Discharge IEC 61000-4-2		±6		kV

DRIVER SWITCHING CHARACTERISTICS

(V_{CC} = +5.0V ±10%, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at V_{CC} = +5.0V and T_A = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Driver Propagation Delay	t _{DPLH}	C _L = 50pF, R _L = 54Ω, Figures 2 and 3			50	ns
	t _{DPHL}				50	
Driver Differential Output Rise or Fall Time	t _R , t _F	C _L = 50pF, R _L = 54Ω, Figures 2 and 3			15	ns
Differential Driver Output Skew t _{DPLH} - t _{DPHL}	t _{DSKEW}	C _L = 50pF, R _L = 54Ω, Figures 2 and 3			8	ns
Maximum Data Rate			16			Mbps
Driver Enable to Output High	t _{DZH}	Figure 4			150	ns
Driver Enable to Output Low	t _{DZL}	Figure 5			150	ns
Driver Disable Time from Low	t _{DLZ}	Figure 5			100	ns
Driver Disable Time from High	t _{DHZ}	Figure 4			100	ns
Driver Enable from Shutdown to Output High	t _{DZH} (SHDN)	Figure 4			2200	ns
Driver Enable from Shutdown to Output Low	t _{DZL} (SHDN)	Figure 5			2200	ns
Time to Shutdown	t _{SHDN}		50	340	700	ns

RECEIVER SWITCHING CHARACTERISTICS

V_{CC} = +5.0V ±10%, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at V_{CC} = +5.0V and T_A = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Receiver Propagation Delay	t _{RPLH}	C _L = 15pF, Figures 6 and 7		50	80	ns
	t _{RPHL}			50	80	
Receiver Output Skew t _{RPLH} - t _{RPHL}	t _{RSKEW}	C _L = 15pF, Figures 6 and 7			13	ns
Maximum Data Rate			16			Mbps
Receiver Enable to Output Low	t _{RZL}	Figure 8			50	ns
Receiver Enable to Output High	t _{RZH}	Figure 8			50	ns
Receiver Disable Time from Low	t _{RLZ}	Figure 8			50	ns
Receiver Disable Time from High	t _{RHZ}	Figure 8			50	ns
Receiver Enable from Shutdown to Output High	t _{RZH} (SHDN)	Figure 8			2200	ns
Receiver Enable from Shutdown to Output Low	t _{RZL} (SHDN)	Figure 8			2200	ns
Time to Shutdown	t _{SHDN}		50	340	700	ns

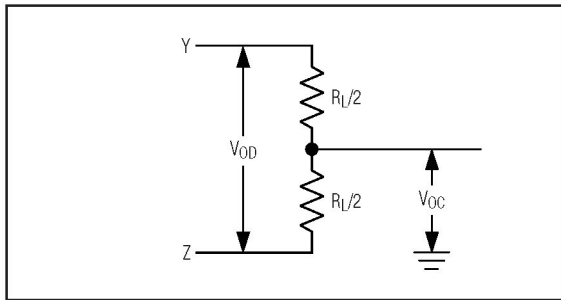


Figure 1. Driver DC Test Load

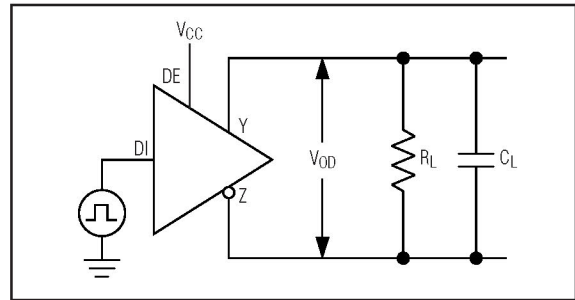


Figure 2. Driver Timing Test Circuit

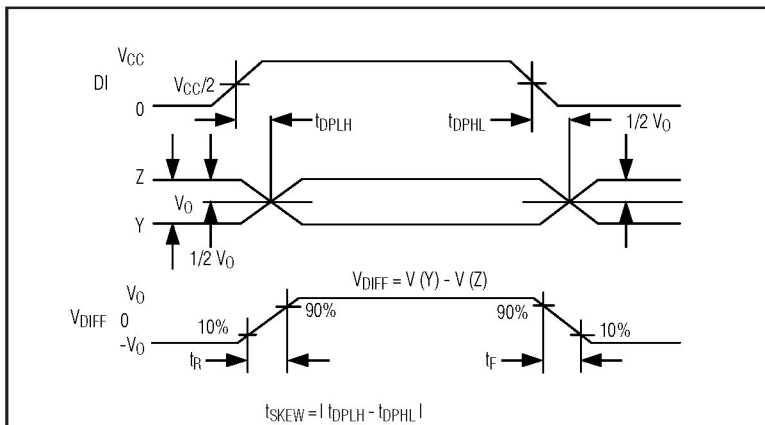


Figure 3. Driver Propagation Delays

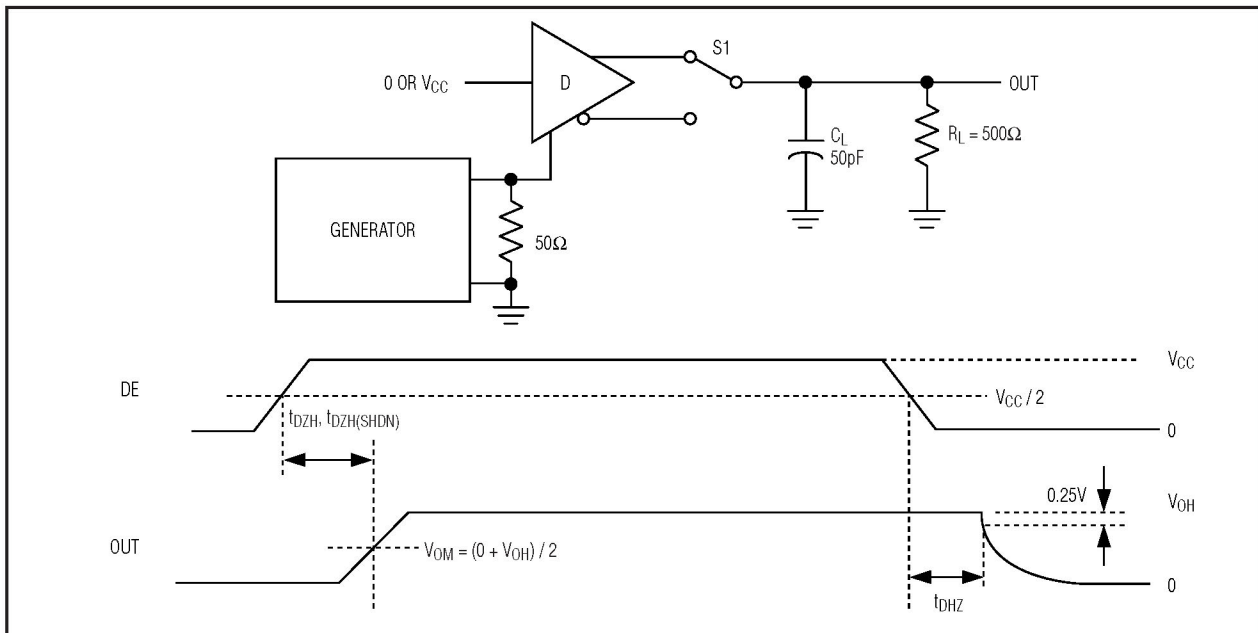


Figure 4. Driver Enable and Disable Times (t_{DZH} , $t_{DZH(SHDN)}$, t_{DHZ})

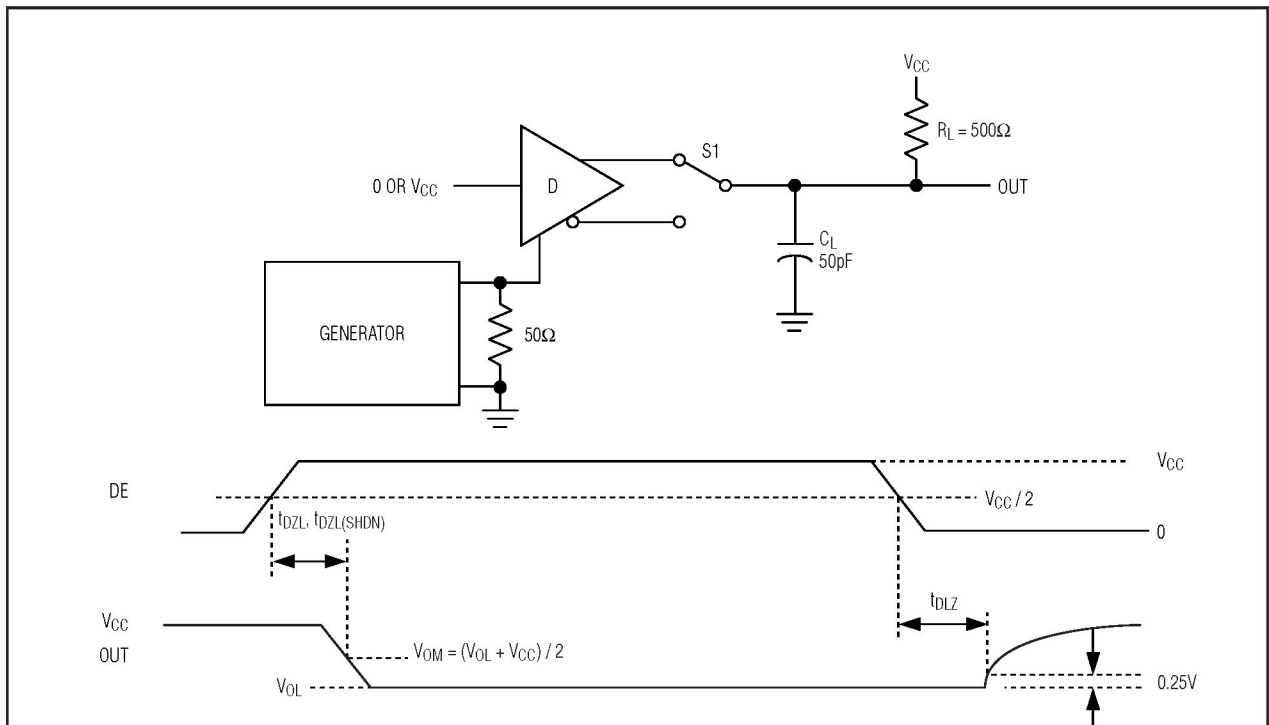


Figure 5. Driver Enable and Disable Times (t_{DZL} , t_{DLZ} , $t_{DLZ(SHDN)}$)

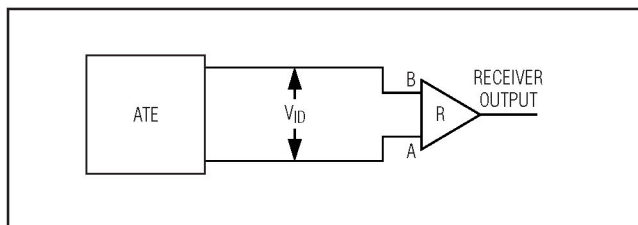


Figure 6. Receiver Propagation Delay Test Circuit

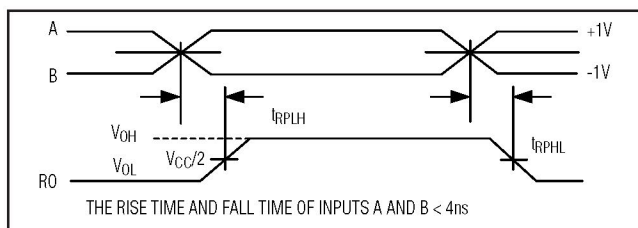


Figure 7. Receiver Propagation Delays

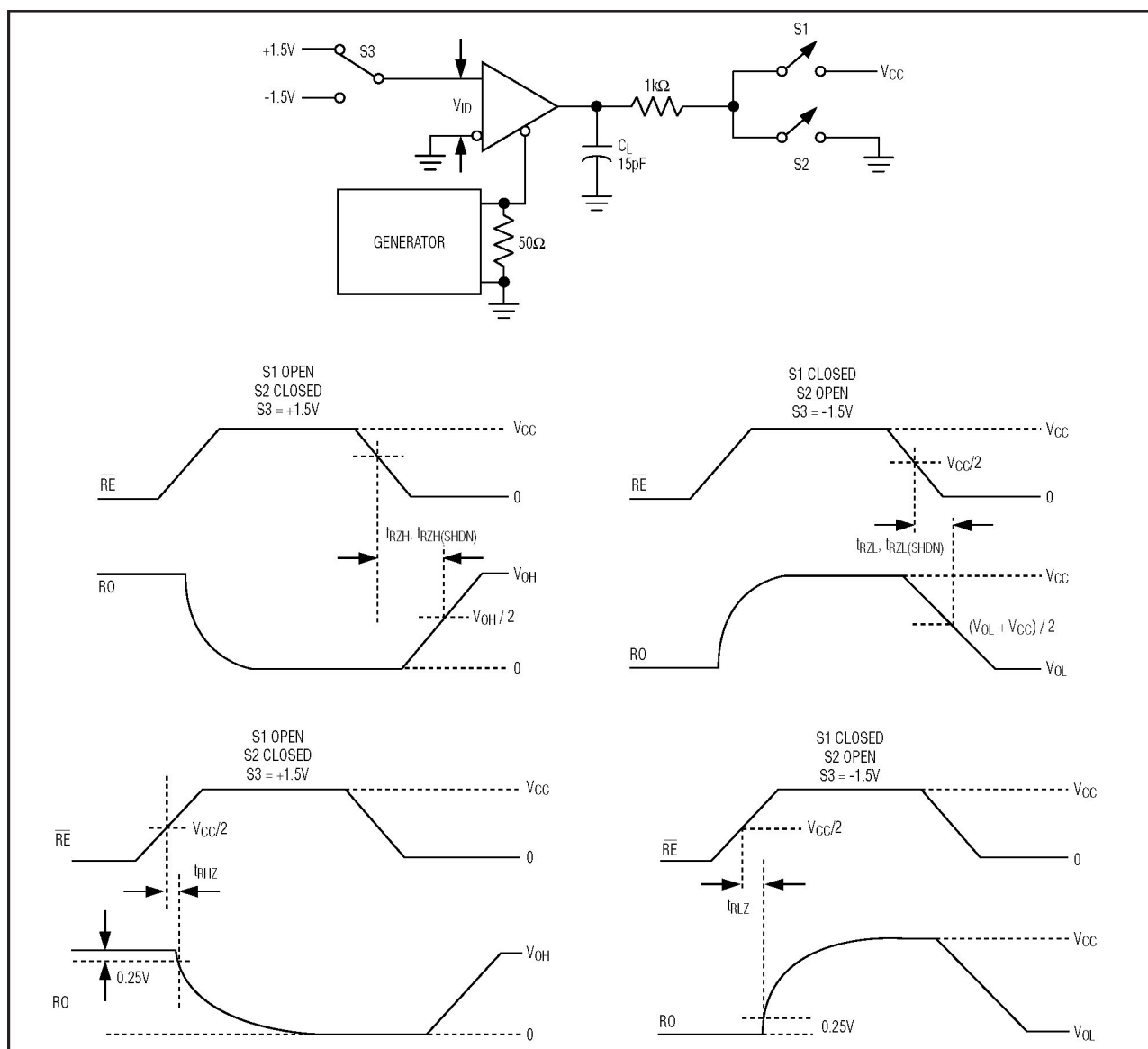
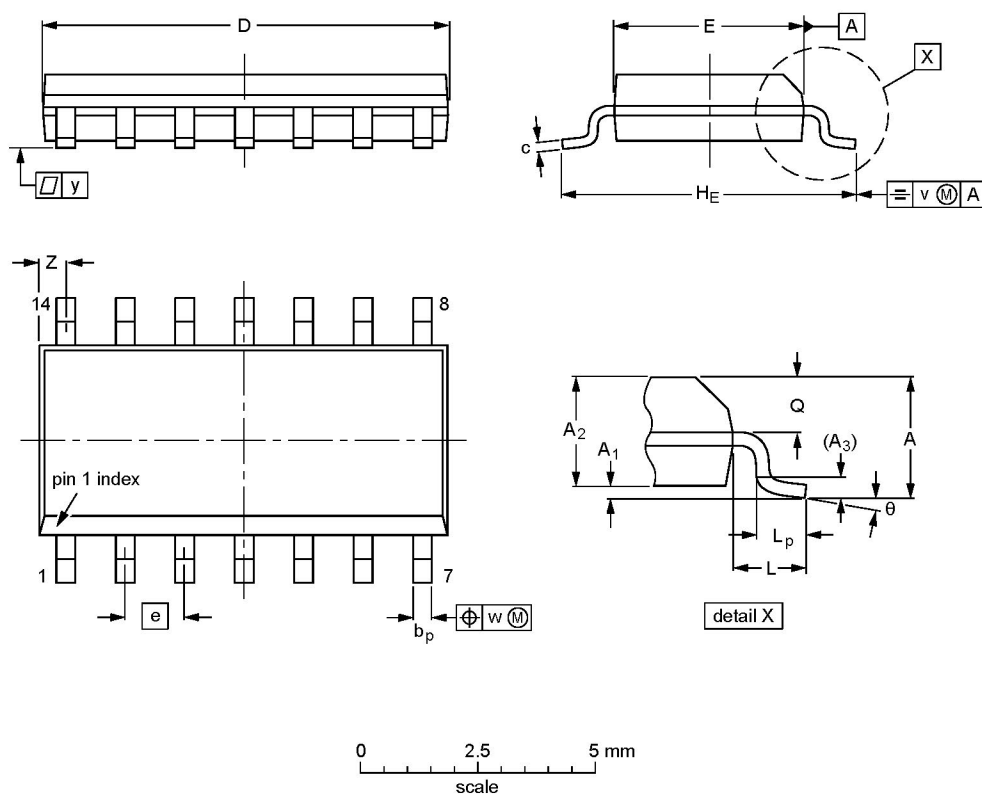


Figure 8. Receiver Enable and Disable Times

Package diagram

SOIC14: plastic small outline package; 14 leads; body width 3.9 mm



DIMENSIONS (mm are the original dimensions)

UNIT	A _{max.}	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8° 0°

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
TKSOIC14						05-06-19